

## Features

- 0603 0.5mm SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

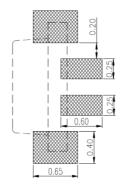
# Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

## Description

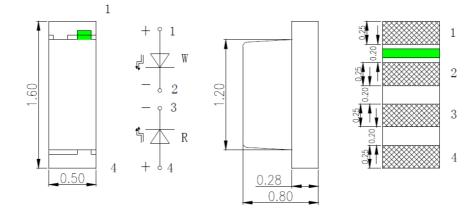
The IN-S63DBS5R5UW is a dual-color 0603, 4pin package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

## **Recommended Solder Pattern**



#### Figure 1. IN-S63DBS5R5UW Solder Pattern

### Package Dimensions in mm



#### Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is  $\pm$  0.10 mm unless otherwise noted

#### Figure 2. IN-S63DBS5R5UW Package Dimensions



## Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	T <sub>OP</sub> (⁰C)	Ts⊤ (°C)
	Red	65		70			
IN-S63DBS5R5UW	White	90	25	90	5	-30ºC~+85ºC	-40°C~+90°C

#### Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

#### **ESD** Precaution

#### ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

### **Electrical Characteristics** $T_A = 25^{\circ}C$ (Note 1)

			V <sub>F</sub> (	V)		λ <b>(nm)</b>		Viewing Angle	l <sup>*</sup> ∨(mcd)
Product	Emission Color	l⊧(mA)	typ.	max	λd	λP	$ riangle \lambda$	<b>2</b> $ heta$ 1/2	l <sup>*</sup> ∨(mcd) typ. 35 200
IN-S63DBS5R5UW	Red	5	1.9	2.2	622	630	20	120	35
	White	5	3.0	3.2	X=0.25 Y=0.22	-	-	120	200

#### Notes

1. Performance guaranteed only under conditions listed in above tables.



## Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range			
	G2	23.0-28.5 mcd			
Red	H1	28.5-35.0 mcd			
Reu	H2	35.0-45.0 mcd			
	J1	45.0-56.0 mcd			
	L2	180.0-230.0 mcd			
White	M1	230.0-285.0 mcd			
vvnite	M2	285.0-350.0 mcd			
	N1	350.0-450.0 mcd			

@5mA / Ta=25<sup>o</sup> C, Tolerance: ± 10%

### Dominant Wavelength ( $\lambda$ D) Bin:

Color	Bin Code	Spec. Range							
	A	615-620							
Red	В	620-625							
	С	625-630							

 $@5mA / Ta=25^{\circ} C$ , Tolerance:  $\pm 0.5nm$ 

## Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
	1	1.8-2.0
Red	2	2.0-2.2
	3	2.2-2.4
	1	2.6-2.8
White	2	2.8-3.0
	3	3.0-3.2

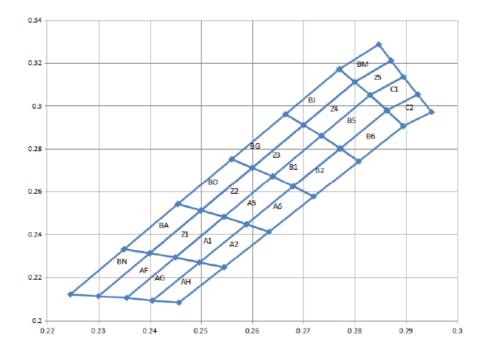
@5mA / Ta=25<sup>o</sup> C, Tolerance: ± 0.05V



## IN-S63DBS5R5UW Side View SMD LED 0603 PCB Type

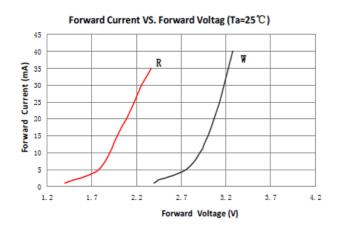
Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y
	0. 2245	0.2118		0.2300	0.2110		0.2355	0.2102		0.2405	0.2089
BN	0.2300	0.2110	AF	0.2355	0.2102	AG	0.2405	0.2089	AH	0.2457	0.2080
DIV	0.2400	0.2310	nı.	0.2450	0.2291	AU	0.2497	0.2267		0.2545	0.2245
	0.2350	0.2329		0.2400	0.2310		0.2450	0.2291		0.2497	0.2267
	0.2350	0.2329		0.2400	0.2310		0.2497	0.2267		0.2497	0.2267
BA	0.2400	0.2310	Z1	0.2500	0.2510	A1	0.2450	0.2290	A2	0.2589	0.2445
Dir	0.2500	0.2510	21	0.2545	0.2480		0.2545	0.2480		0.2633	0.2410
	0.2455	0.2540		0.2450	0.2291		0.2589	0.2445		0.2545	0.2245
	0.2455	0.2540	ļ	0.2500	0.2510		0.2545	0.2480		0.2589	0.2445
BD	0.2500	0.2510	Z2	0.2600	0.2710	A5	0.2589	0.2445	A6	0.2633	0.2410
	0.2600	0.2710		0.2640	0.2670		0.2680	0.2623		0.2720	0.2575
	0.2560	0.2750		0.2545	0.2480		0.2640	0.2670		0.2680	0.2623
	0.2560	0.2750	-	0.2600	0.2710		0.2640	0.2670		0.2720	0.2575
BG	0.2600	0.2710	Z3	0.2700	0.2910	B1	0.2680	0.2623	B2	0.2680	0.2623
	0.2700	0.2910		0.2735	0.2860		0.2772	0.2800		0.2772	0.2800
	0.2665	0.2960		0.2640	0.2670		0.2735	0.2860		0.2808	0.2740
	0.2665	0.2960	ļ	0.27	0.291		0.2735	0.2860		0.2772	0.2800
BJ	0.2700	0.2910	Z4	0.28	0.311	B5	0.2772	0.2800	B6	0.2808	0.2740
25	0.2800	0.3110	21	0.283	0.305	20	0.2863	0.2978		0.2895	0.2905
	0.2770	0.3170		0.2735	0.286		0.2830	0.3050		0.2863	0.2978
	0.2770	0.3170		0.28	0.311		0.2830	0.3050		0.2863	0.2978
BM	0.2800	0.3110	Z5	0.2871	0.321	C1	0.2863	0.2978	C2	0.2895	0.2905
Dil	0.2871	0.3210	20	0.2895	0.3134	01	0.2923	0.3052		0.2950	0.2970
	0.2847	0.3286		0.283	0.305		0.2895	0.3134		0.2923	0.3052

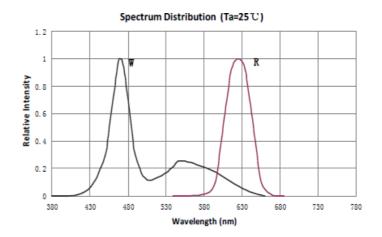
# White Bin Range of Wavelength

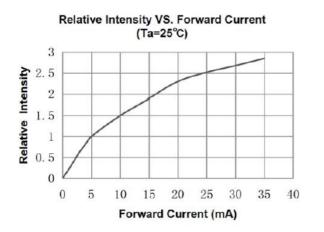




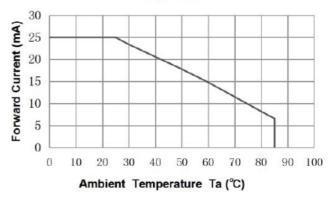
# **Typical Characteristic Curves**



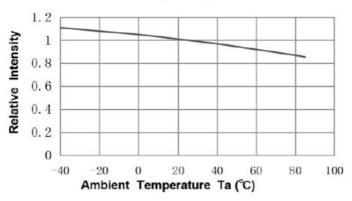




Maximum Forward Current VS. Ambient temperature

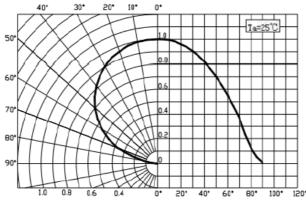


Relative Intensity VS. Ambient Temperature (Ta=25°C)





# **Typical Characteristic Curves – Radiation Pattern**



spatial distribution

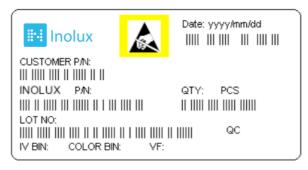
## **Ordering Information**

Product	Emission Color	Test Current I <sub>F</sub> (mA)	Luminous Intensity I <sub>V</sub> (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
IN-S63DBS5R5UW	Red	5	30	1.9	IN-S63DBS5R5UW
IN-303DB33K30W	White	5	200	2.8	IN-303DB33K30W

• Bin Range specified on page 3.



## **Label Specifications**



# Inolux P/N:

I	Ν	-	S	6	3	D	В	S	5	R	5	U	W	-	
			Material	Pacl	kage	Varia	ation	Orientation	Curren t	Color	Curren t	Lens	Color		Customized Stamp-off
	olux MD		S = PCB Type	1.	6 x 0.8	0B = x 0.5m chip	ım	S = Side Mount	5= 5mA	R= 622nm	5= 5mA	U = Diffused	W= White		

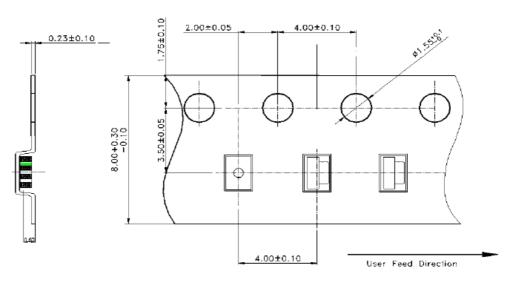
#### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2018)	Month	Date	Serial	
Tracker			, 2010,,		Wienen	Date	Serial

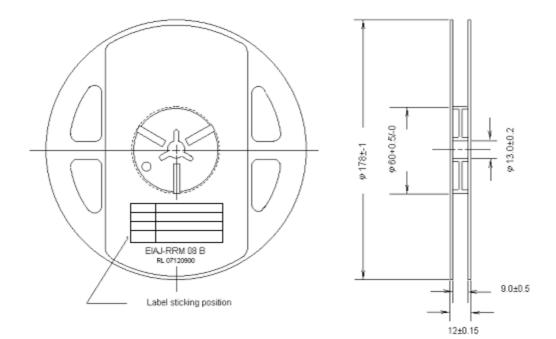


## Packaging Information: 4000pcs Per Reel

# Tape Dimension

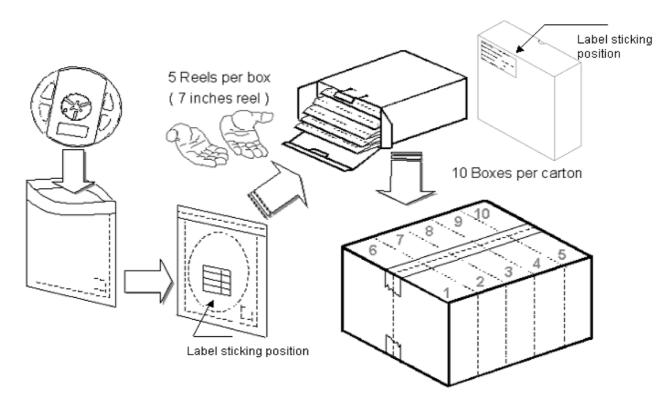


## **Reel Dimension**





## Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	• •
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_{D}$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

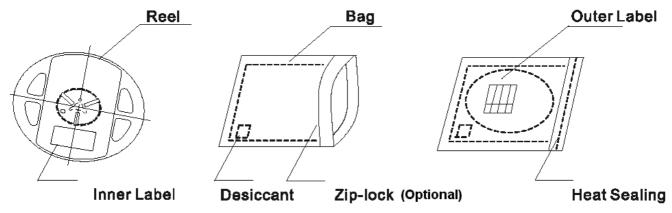


## **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

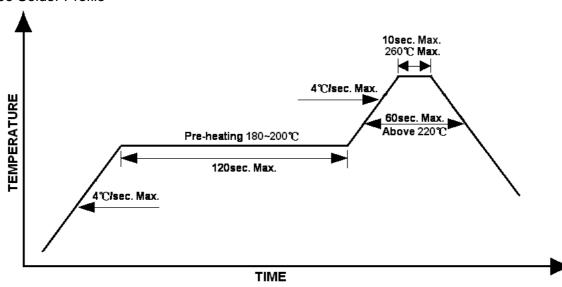
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



## **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



## Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

## **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



# **Reliability**

Item		Standards	Conditions
	failures	Reference	
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
-			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55°C
bias		-	IF=20mA
DIAS			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
<b>T</b>		IEC 68-2-14, Nb	15min
Temperature			Thermal steady within 5 min
cycle			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



### **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	04-15-2020
Updated	P1	V1.1	09-04-2020

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